



**GHz TECHNOLOGY**  
RF·MICROWAVE SILICON POWER TRANSISTORS

**0204-125**

125 Watts, 28 Volts, Class AB  
Defcom 225 - 400 MHz

### GENERAL DESCRIPTION

The 0204-125 is a double input matched COMMON Emitter broadband transistor specifically intended for use in the 225-400 MHz frequency band. It may be operated in Class AB or C. Gold metallization and silicon diffused resistors ensure ruggedness and high reliability.

### ABSOLUTE MAXIMUM RATINGS

Maximum Power Dissipation @ 25°C                    270 Watts

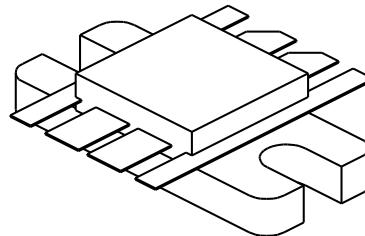
#### Maximum Voltage and Current

BVces	Collector to Emitter Voltage	65 Volts
BVebo	Emitter to Base Voltage	4.0 Volts
Ic	Collector Current	16.0 A

#### Maximum Temperatures

Storage Temperature	- 65 to +150°C
Operating Junction Temperature	+200°C

### CASE OUTLINE 55JT- Style 2



### ELECTRICAL CHARACTERISTICS @ 25 °C

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN	TYP	MAX	UNITS
<b>Pout</b>	Power Output	F = 400 MHz	125			Watts
<b>Pin</b>	Power Input	Vcc = 28 Volts			25	Watts
<b>Pg</b>	Power Gain		7.0	8.5		dB
<b>ηc</b>	Efficiency			60		%
<b>VSWR</b>	Load Mismatch Tolerance				5:1	

<b>BVebo<sup>2</sup></b>	Emitter to Base Breakdown	Ie = 10 mA	4.0			Volts
<b>BVces<sup>2</sup></b>	Collector to Emitter Breakdown	Ic = 100 mA	60			Volts
<b>BVceo<sup>2</sup></b>	Collector to Emitter Breakdown	Ie = 100 mA	32			Volts
<b>Cob<sup>2</sup></b>	Output Capacitance	Vcb = 28 V, F = 1 MHz			70	pF
<b>h<sub>FE</sub><sup>2</sup></b>	DC - Current Gain	Vce = 5 V, Ic = 1 A	20		100	
<b>θ<sub>jc</sub></b>	Thermal Resistance				0.65	°C/W

Note 2: Per side

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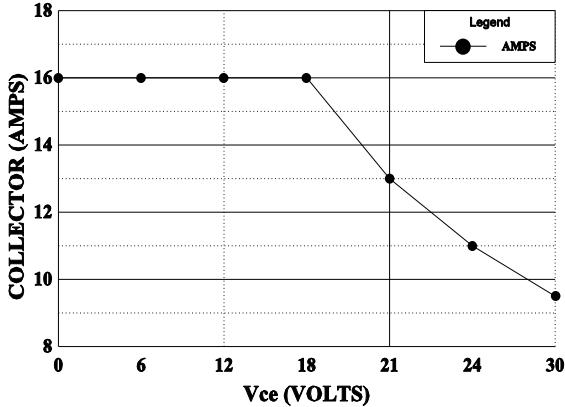
GHz Technology Inc. 3000 Oakmead Village Drive, Santa Clara, CA 95051-0808 Tel. 408 / 986-8031 Fax 408 / 986-8120



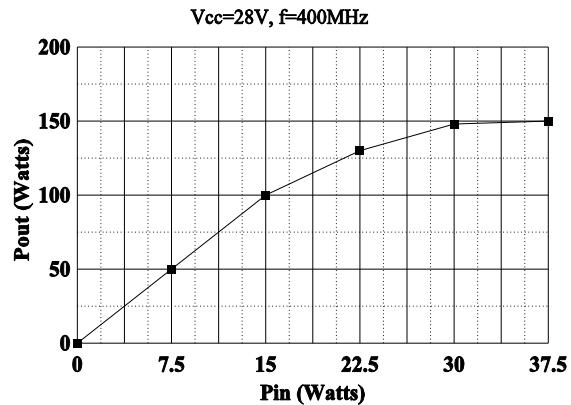
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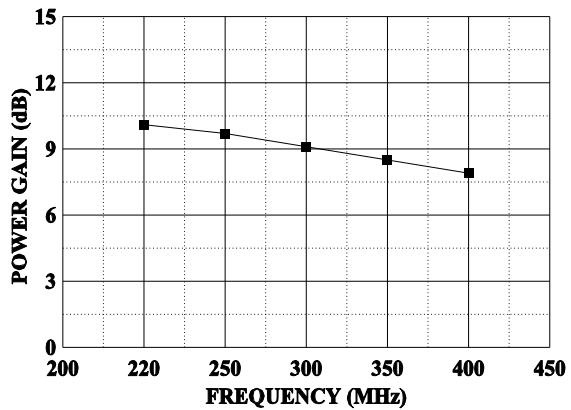
**DC SAFE OPERATING AREA**



**POWER OUTPUT vs POWER INPUT**

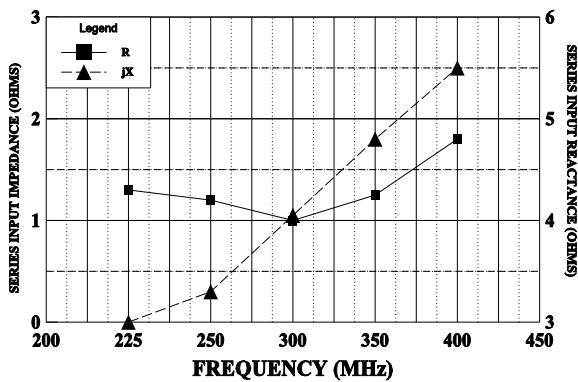


**POWER GAIN VS FREQUENCY**



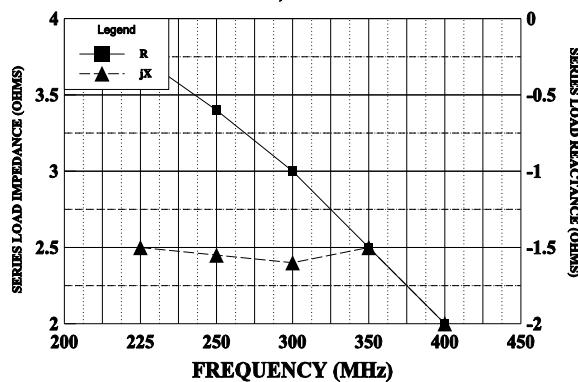
**SERIES INPUT IMPEDANCE vs FREQUENCY**

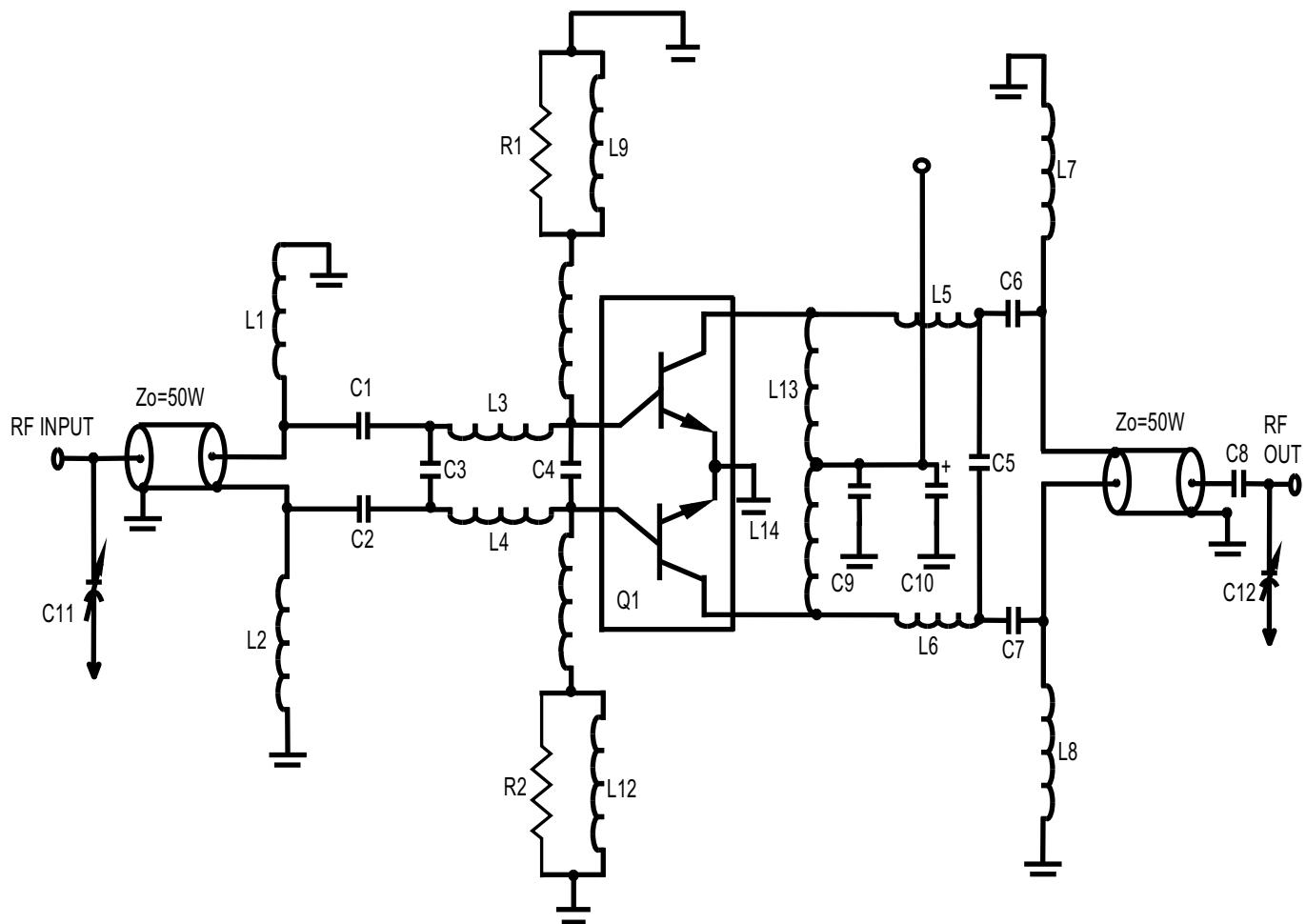
Po=125 W Vcc= 28 V



**SERIES LOAD IMPEDANCE vs FREQUENCY**

Po = 125 W, Vcc = 28 V





#### CAPACITORS

C1,C2=39pF ceramic chip capacitor  
 C3=33pF ceramic chip capacitor  
 C4=56pF ceramic chip capacitor  
 C5=18pF ceramic chip capacitor  
 C6,C7,C8=27pF ceramic chip capacitor  
 C9=0.1mF ceramic capacitor  
 C10=10mF electrolytic capacitor  
 C11,C12=.5-10pF Johanson

#### INDUCTORS

L1,L2,L3,L4,L5,L6,L7,L8=printed  
on the circuit board  
 L9,L12=4.7mH RF choke  
 L10,L11,L13,L14=0.1mH RF choke

#### RESISTORS

R1,R2=10 OHM, 1/4 W

#### TRANSISTOR

Q1=0204-125